# **2SB1599**

## Silicon PNP epitaxial planar type

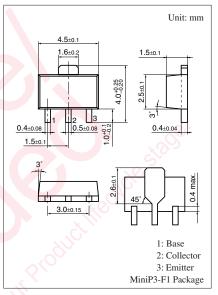
For power amplification Complementary to 2SD2457

#### Features

- Low collector-emitter saturation voltage V<sub>CE(sat)</sub>
- Mini Power type package, allowing downsizing of the equipment and automatic insertion through the tape packing and the magazine packing.

Absolute Maximum Ratings $T_a = 25^{\circ}C$						
Parameter	Symbol	Rating	Unit			
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	-50	V			
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	-40	V			
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	-5	V			
Collector current	I <sub>C</sub>	-1.5	А			
Peak collector current	I <sub>CP</sub>	-3	A			
Collector power dissipation *	P <sub>C</sub>	1	w			
Junction temperature	Tj	150	°Ç			
Storage temperature	T <sub>stg</sub>	-55 to +150	°C			





#### Marking Symbol: 1X

Note) \*: Print circuit board: Copper foil area of 1 cm<sup>2</sup> or more, and the board thickness of 1.7 mm for the collector portion

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

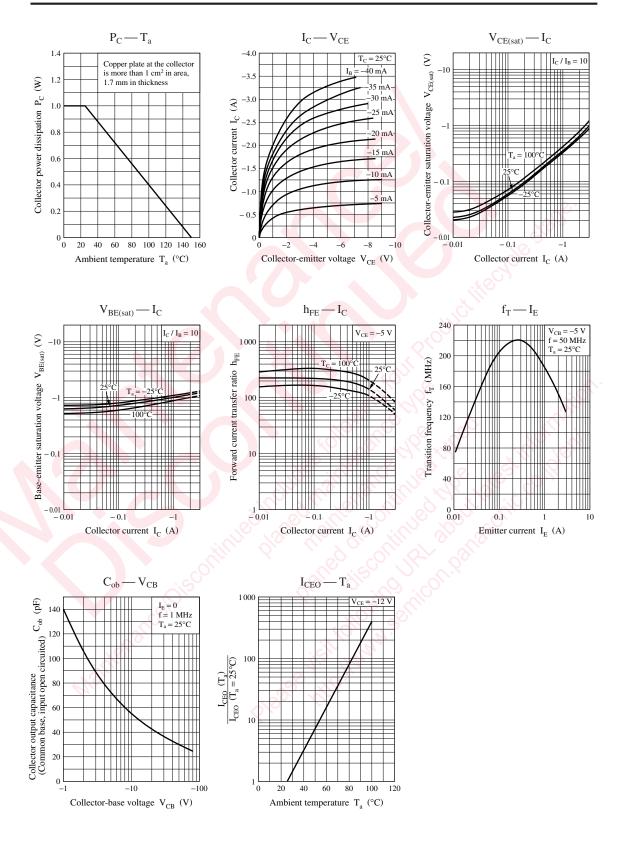
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = -1 \text{ mA}, I_{\rm E} = 0$	-50			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = -10 \text{ mA}, I_{\rm B} = 0$	-40			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = -20 \text{ V}, I_E = 0$			-1	μΑ
Collector-emitter cutoff current (Base open)	I <sub>CEO</sub>	$V_{CE} = -12 \text{ V}, I_B = 0$			-100	μΑ
Emitter-base cutoff current (Collector open)	I <sub>EBO</sub>	$V_{EB} = -5 V, I_C = 0$			-100	μΑ
Forward current transfer ratio *	h <sub>FE</sub>	$V_{CE} = -5 V, I_C = -1 A$	80		220	
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = -1.5 \text{ A}, I_{\rm B} = -0.15 \text{ A}$		- 0.4	-1.0	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{\rm C} = -2$ A, $I_{\rm B} = -0.2$ A			-1.5	V
Transition frequency	f <sub>T</sub>	$V_{CB} = -5 \text{ V}, I_E = 0.5 \text{ A}, f = 200 \text{ MHz}$		150		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = -5 V, I_E = 0, f = 1 MHz$		70		pF

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Rank classification

Rank	Q	R
$h_{FE}$	80 to 160	100 to 220

## **Panasonic**



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